

# **DATA SHEET**

## AUTOMOTIVE GRADE SURGE CHIP RESISTORS

SR series

20%, 10%, 5% 1%, 0.5%

sizes 0201/0402/0603/0805/1206/1210/1218/2010/2512 RoHS compliant & Halogen free



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This specification describes SR0201 to SR2512 chip resistors with lead-free terminations made by thick film process.

#### **APPLICATIONS**

- Telecommunications
- Power supplies
- Car electronics

#### **FEATURES**

- AEC-Q200 qualified
- Superior to RC series in pulse withstanding voltage and surge withstanding voltage.
- MSL class: MSL I
- Halogen free epoxy
- RoHS compliant
  - Products with lead-free terminations meet RoHS requirements
  - Pb-glass contained in electrodes, resistor element and glass are exempted by RoHS
- Reduce environmentally hazardous waste
- High component and equipment reliability

#### ORDERING INFORMATION - GLOBAL PART NUMBER

Part number is identified by the series name, size, tolerance, packaging type, temperature coefficient, taping reel and resistance value.

#### **GLOBAL PART NUMBER**

### SR XXXX X X X XX XXXX L

(1) (2) (3) (4) (5) (6) (7)

#### (I) SIZE

0201 / 0402 / 0603 / 0805 / 1206 / 1210 / 1218 / 2010 / 2512

### (2) TOLERANCE

 $D = \pm 0.5\%$ 

 $F = \pm 1\%$ 

 $| = \pm 5\%$ 

 $K = \pm 10\%$ 

 $M = \pm 20\%$ 

#### (3) PACKAGING TYPE

R = Paper taping reel

K = Embossed taping reel

#### (4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Based on spec.

#### (5) TAPING REEL & POWER

07 = 7 inch dia. Reel & Standard power

7W = 7 inch dia. Reel & 2 x standard power 7T = 7 inch dia. Reel & 3 x standard power

13 = 13 inch dia, Reel

47 = 7 inch dia, Reel & 4xstandard power

### (6) RESISTANCE VALUE

 $I \Omega \leq R \leq IM \Omega$ 

There are  $2\sim4$  digits indicated the resistance value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed coding rules of resistance are shown in the table of "Resistance rule of global part number".

#### (7) DEFAULT CODE

Letter L is the system default code for ordering only. (Note)

Resistance rule of global part				
Resistance coding rule	Example			
XRXX (1 to 9.76 Ω)	IR = I Ω $IR5 = I.5 Ω$ $9R76 = 9.76 Ω$			
XXRX (10 to 97.6 Ω)	$10R = 10 \Omega$ $97R6 = 97.6 \Omega$			
XXXR (100 to 976 Ω)	100R = 100 Ω			
XKXX (1 to 9.76 K <b>Ω)</b>	IK = I,000 Ω 9K76 = 9760 Ω			
XXKX (10 to 97.6 KΩ)	$10K = 10,000 \Omega$ 97K6= 97,600 Ω			
XXXK (100 KΩ)	100K = 100,000 Ω			

### **ORDERING EXAMPLE**

The ordering code for an SR0805 chip resistor, value  $10~\text{K}\Omega$  with  $\pm 5\%$  tolerance, supplied in 7-inch tape reel is: SR0805JR-0710KL.



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### **MARKING**

### SR0201 / SR0402



No Marking

Fig. I

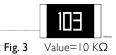
SR1218



E-24 series: 3 digits

First two digits for significant figure and 3rd digit for number of zeros

### SR0603 / SR0805 / SR1206 / SR1210 / SR2010 / SR2512



E-24 series: 3 digits

First two digits for significant figure and 3rd digit for number of zeros

### NOTE

For further marking information, please refer to data sheet "Chip resistors marking".

### TAPING REEL & POWER

### Table I

		POWER	R, W (P70)	
TYPE		СО	DING	
(	07	7W	<b>7</b> T	47
0201	1/20	1/10	-	1/5
0402	1/16	1/8	1/5	-
0603	1/10	1/5	1/4	1/3
0805	1/8	1/4	1/3	1/2
1206	1/4	1/2	3/4	1
1210	1/2	1	-	-
1218	I	1.5	-	-
2010 3	3/4	1.25	-	-
2512	l	2	=	=

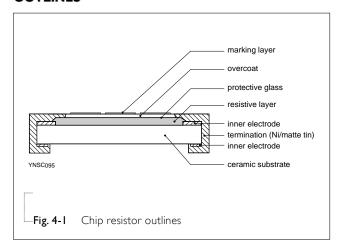


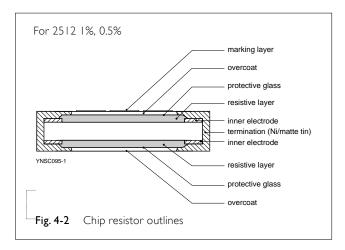
### **CONSTRUCTION**

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The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive glaze. The resistive glaze is covered by a lead-free glass. The composition of the glaze is adjusted to give the approximately required resistance value. The whole element is covered by a protective overcoat. The top of overcoat is marked with the resistance value. Finally, the two external terminations (Ni/matte tin) are added, as shown in Fig.4.

#### **OUTLINES**

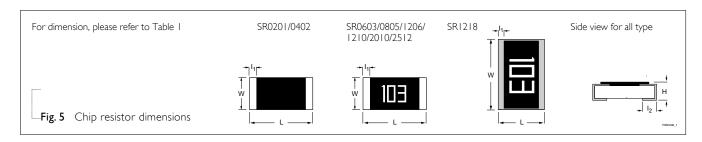




### <u>DIMENSIONS</u>

Table 2

TYPE	L (mm)	W (mm)	H (mm)	I <sub>1</sub> (mm)	I <sub>2</sub> (mm)
SR0201	0.60±0.03	0.30±0.03	0.23±0.03	0.12±0.05	0.15±0.05
SR0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
SR0603	1.60±0.10	0.80±0.10	0.45±0.10	0.25±0.15	0.25±0.15
SR0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
SR1206	3.10±0.10	1.60±0.10	0.55±0.10	0.45±0.20	0.45±0.20
SR1210	3.10±0.10	2.60±0.15	0.55±0.10	0.45±0.15	0.50±0.20
SR1218	3.10±0.10	4.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
SR2010	5.00±0.10	2.50±0.15	0.55±0.10	0.55±0.15	0.55±0.20
SR2512	6.35±0.10	3.10±0.15	0.55±0.10	0.60±0.20	0.60±0.20



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### ELECTRICAL CHARACTERISTICS

### Table 3

			CHARACTERISTICS				
TYPE	POWER	resistance range	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
SR0201	1/20W 1/10W 1/5W		-55 °C to +155 °C	25 V	50 V	50 V	$I\Omega \le R < I0\Omega$ - $I00 \sim +350 \text{ ppm}^{\circ}\text{C}$ $I0\Omega \le R \le IM\Omega$ $\pm 200 \text{ ppm}^{\circ}\text{C}$
SR0402	1/16W 1/8W 1/5W			75 V	100 V	100 V	
SR0603	1/10W 1/5W 1/4W			150V	300V	300V	
SR0805	1/3W 1/8 W 1/4W 1/3W	E24/E96 0.5%, 1% E24 5%, 10%, 20% $I\Omega \le R \le I0M\Omega$ for 0402, 0603, 0805,		500V	1000V	1000V	$ 0\Omega \le R \le  0M\Omega $
SR I 206	1/2W 1/4 W 1/2W 3/4W 1W	1206, 2010 $I\Omega \le R \le IM\Omega$ for 0201, 1210, 1218, 2512		500V	1000V	1000V	$\pm 100 \text{ ppm/ °C}$ $1\Omega \leq R < 10\Omega$ $\pm 200 \text{ ppm/ °C}$
SR1210	1/2W			500V	1000V	1000V	
SR1218	1.5W			200 V	400 V	500 V	
SR2010	3/4W 1.25W			200 V	400 V	500 V	
SR2512	I W			500 V	1000 V	1000 V	





### **Chip Resistor Surface Mount**

SR SERIES

### FOOTPRINT AND SOLDERING PROFILES

Recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting".

### PACKING STYLE AND PACKAGING QUANTITY

Table 4 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	SR0201/0402	SR0603/0805/1206	SR1210	SR1218/2010/2512
Paper taping reel (R)	7" (178 mm)	10,000	5,000	5,000	
	13" (330 mm)	50,000	20,000	20,000	
Embossed taping reel (K)	7" (178 mm)				4,000

### NOTE

#### FUNCTIONAL DESCRIPTION

### **OPERATING TEMPERATURE RANGE**

Range: -55 °C to +155 °C

#### **POWER RATING**

Each type rated power at 70 °C: SR0201: I/20W, I/10W, I/5W SR0402: I/16W, I/8W, I/5W

SR0603: 1/10W, 1/5W, 1/4W, 1/3W SR0805: 1/8W, 1/4W, 1/3W, 1/2W SR1206: 1/4W, 1/2W, 3/4W, 1W

SR1210: 1/2W, 1W SR1218: 1W, 1.5W SR2010: 3/4W, 1.25W SR2512: 1W, 2W

#### **RATED VOLTAGE**

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

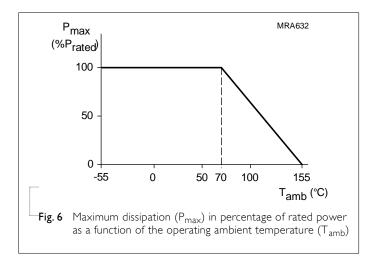
$$V = \sqrt{(P \times R)}$$

or max. working voltage whichever is less Where

V = Continuous rated DC or AC (rms) working voltage (V)

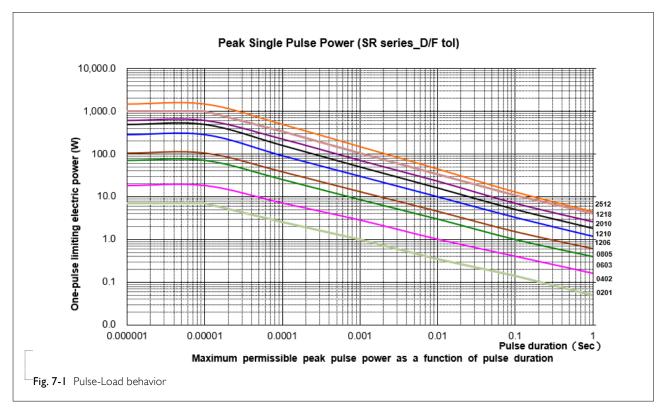
P = Rated power (W)

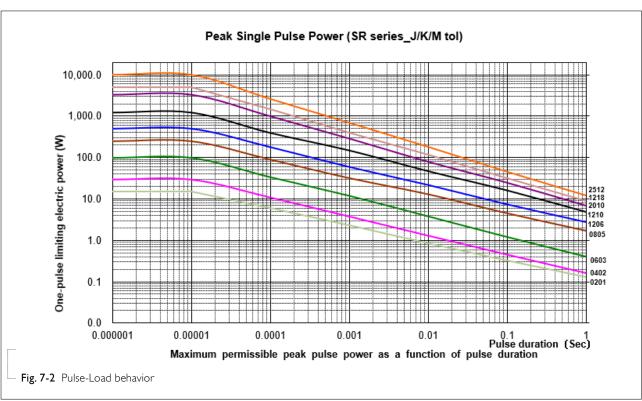
 $R = Resistance value (\Omega)$ 



I. For paper/embossed tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".

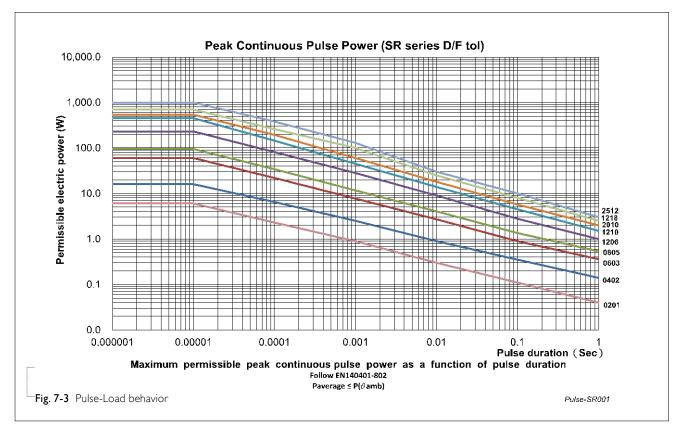
### Pulse load Behavior

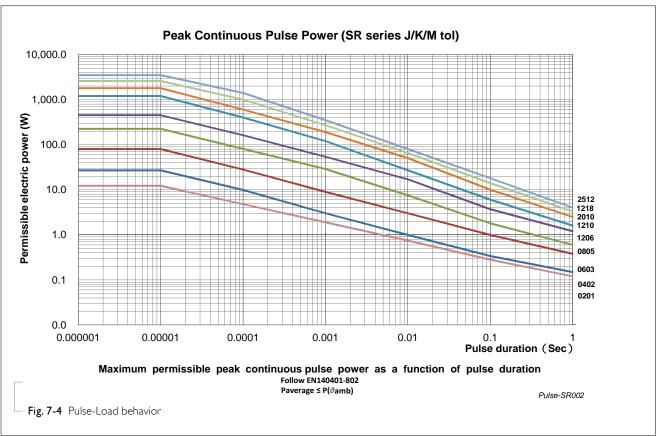






### Pulse load Behavior









### TESTS AND REQUIREMENTS

\_\_\_Table 5 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS	
High Temperature	AEC-Q200 Test 3	1,000 hours at $T_A = 155$ °C, unpowered	$\pm (2.0\% + 0.05\Omega)$ for D/F tol	
Exposure	MIL-STD-202 Method 108		$\pm (3.0\% {+} 0.05 \Omega)$ for others	
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at	$\pm (0.5\% + 0.05\Omega)$ for D/F tol	
		8 hours, 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	$\pm (2.0\% {+} 0.05 \Omega)$ for others	
Biased	AEC-Q200 Test 7	1,000 hours; 85 °C / 85% RH	$\pm (1.0\% + 0.05\Omega)$ for D/F tol	
Humidity	MIL-STD-202 Method 103	10% of operating power	$\pm (3.0\% + 0.05\Omega)$ for others	
		Measurement at 24±4 hours after test conclusion.		
Operational Life	AEC-Q200 Test 8	1,000 hours at 125 °C, derated voltage applied	$\pm (2.0\% + 0.05\Omega)$ for D/F tol	
	MIL-STD-202 Method 108	for 1.5 hours on, 0.5 hour off, still-air required	$\pm(3.0\% {\pm} 0.05\Omega)$ for others	
Resistance to	AEC-Q200 Test 15	Condition B, no pre-heat of samples	±(1.0%+0.05Ω)	
Soldering Heat	MIL-STD-202 Method 210	Lead-free solder, 260 $\pm$ 5 °C, 10 $\pm$ 1 seconds immersion time	No visible damage	
		Procedure 2 for SMD: devices fluxed and cleaned with isopropanol		
Thermal Shock	MIL-STD-202 Method 107	-55/+125 °C	$\pm (0.5\% + 0.05\Omega)$ for D/F tol	
		Number of cycles is 300. Devices mounted	$\pm (1.0\% {+} 0.05 \Omega)$ for others	
		Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air		
ESD	AEC-Q200 Test 17	Human Body Model,	±(3.0%+0.05Ω)	
	AEC-Q200-002	I pos. + I neg. discharges		
		0201: 500V		
		0402/0603: IKV		
		0805 and above: 2KV		
Solderability	AEC-Q200 Test 18	Electrical Test not required Magnification 50X	Well tinned (≥95% covered)	
- Wetting	J-STD-002	SMD conditions:	No visible damage	
		(a) Method B, aging 4 hours at 155 °C dry heat, dipping at 235±3 °C for 5±0.5 seconds.	No visiole dall'idge	
		(b) Method B, steam aging 8 hours, dipping at $215\pm3~^{\circ}\text{C}$ for $5\pm0.5$ seconds.		
		(c) Method D, steam aging 8 hours, dipping at 260±3 °C for 30±0.5 seconds.		

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Board Flex	AEC-Q200 Test 21 AEC-Q200-005	Chips mounted on a 100mm x 40mm glass $\pm (1.0\% + 0.05\Omega)$ epoxy resin PCB (FR4)	
	•	Bending for 0201/0402: 5 mm 0603/0805: 3 mm 1206 and above: 2 mm	
		Holding time: minimum 60 seconds	
Temperature MIL-STD-202 Method 304 Coefficient of Resistance (T.C.R.)		At +25/-55 °C and +25/+125 °C  Formula:  T.C.R= $\frac{R_2-R_1}{R_1(t_{2S}-t_1)} \times 10^6 \text{ (ppm/°C)}$	Refer to table 2
		Where $t_1$ =+25 °C or specified room temperature $t_2$ =-55 °C or +125 °C test temperature $R_1$ =resistance at reference temperature in ohms $R_2$ =resistance at test temperature in ohms	
Short Time Overload	IEC60115-1 8.1	2.5 times of rated voltage or maximum overload voltage whichever is less for 5 sec at room temperature	±(2.0%+0.05Ω)



# Chip Resistor Surface Mount SR SERIES 0201/0402/0603/0805/1206/1210/1218/2010/2512

### REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 14	Feb. 14, 2025	-	- Extend resistance range of 0402,0603,0805,1206,2010 to 10Mohm.
Version 13	Jul. 23, 2024	-	- Upgrade the working voltage of 1206 and 1210 to 500V
Version 12	Apr. 23, 2024	-	- Add continuous pulse curve
Version 11	Aug. 31, 2023	-	- Upgrade the working voltage of 2512 to 500V
-			- Merge F/D tol
			Add size 0201
\/===:== 10	A - 02 2022		Upgrade the working voltage of 0402 to 75V
Version 10	Aug. 02, 2022	-	Upgrade the working voltage of 0603 to 150V
			Upgrade the working voltage of 0805 to 500V
			12 dimension updated, for size 1206, size 2010, size 2512
Version 9	Aug. 04, 2021	-	- Upgrade to Automotive Grade
Version 8	Jul. 22, 2019	-	- Update power rating
Version 7 Sep. 27, 2018		- Extend resistance range of 0402 ~ 2512 to IMohm,	
	C - 27 2010	-	- Tighten TCR of all sizes for $10\Omega < R \le IM\Omega$ from $\pm$ 200 ppm/°C to
	Sep. 27, 2018		± 100 ppm/°C
			- Add SR1210, SR1218, SR2010 7W (double power)
· · · · · · · · · · · · · · · · · · ·		- Add SR0402 7T (triple power), SR0805 47 (quadruple power),	
Version 6	Oct. 02, 2017	=	SR2512 7W (double power)
Version 5	Nov.11, 2016	-	- Update 7T power for 1206
\/	C 01 2015		- Update SR0603 Dielectric Withstanding Voltage to 150V
Version 4	Sep. 01, 2015	-	- Update 7T power for 0603/0805 & 7W for 1210
Version 3	Jul. 31, 2015	-	- Comply with AEC-Q200 standard
Version 2 Jan. 06, 2014		- Add SR0402/0603/1210	
	Jan. 06, 2014	-	- Update electrical characteristic
Version I Mar 18, 20		-	- Change to dual brand datasheet that describes SR0805 to SR2512 with
	Mar 18, 2011		RoHS compliant
			- Define global part number
Version 0	Oct 19, 2004	-	-



**Chip Resistor Surface Mount** 

SERIES

SR

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